

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification# 20190821004 Datasheet for DAC8740H, DAC8741H Information Only

Date: August 23, 2019

To: PREMIER FARNELL PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN team (PCN www admin team@list.ti.com).

Sincerely,

PCN Team SC Business Services

Information Only Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE DAC8740HRGET

CUSTOMER PART NUMBER

null

Technical details of this Product Change follow on the next page(s).

			1					1			
PCN Number:		20190821004				PCN Date:	Aug. 23, 2019				
Tit	le:	Datasheet for	DAC	8740H,	DA	C8741H					
Customer Contact: PCN Manager			<u>er</u>				ept:	Quality Services			
Ch	ange	Type:									
Assembly Site				Design			Wafer Bump Site				
Assembly Process			\boxtimes	□ Data Sheet			Wafer Bump Material				
Assembly Materials				Part number change			Wafer Bump Process				
Mechanical Specification			Щ	Test Site			Wafer Fab Site				
Packing/Shipping/Labeling			Ш	Test Process				er Fab Materials			
					- 141 - 1				Wafer Fab Process		
_					No	<u>tificatio</u>	n Details				
Description of Change:											
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.											
TEXAS INSTRUMENTS DAC8740H, DAC8741H SBASSS56D – JUNE 2017 – REVISED MAY 2019									•		
c	Changes from Revision C (December 2018) to Revision D										
Added recommended operating temperature range, T _A , to the <i>Recommended Operating Conditions</i> table											
The	e data	asheet number	will be	e chanc	aina	l .					
The datasheet number will be changing. Device Family			Change From:			Change To:					
DAC8740H, DAC8741H				SBAS85			SBAS856D				
These changes may be reviewed at the datasheet links provided.											
http://www.ti.com/product/DAC8740H											
Reason for Change:											
To accurately reflect device characteristics.											
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):											
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.											
	Changes to product identification resulting from this PCN:										
None.											
Pro	oduc	t Affected:									
	DAC8740HRGER DAC8740HRG			GET	DAC8741HRGER			DAC8741HRGET			

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com

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